

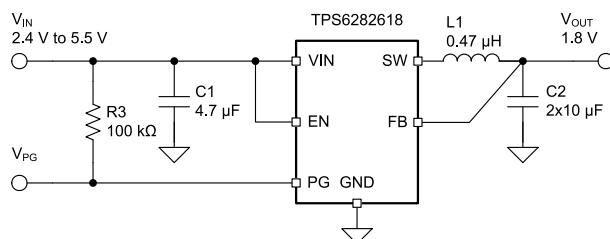
# 采用 1.5mm × 1.5mm QFN 封装且具有 1% 输出精度的 TPS6282x 2.4V 至 5.5V 输入、1/2/3/4A 降压转换器

## 1 特性

- 可作为集成电感器的电源模块：TPSM82821 和 TPSM82822
- DCS-Control™ 拓扑
- 1% 反馈或输出电压精度（整个温度范围）
- 效率高达 97%
- 26mΩ 和 25mΩ 内部功率 MOSFET
- 2.4V 至 5.5V 输入电压范围
- 4μA 工作静态电流
- 2.2MHz 开关频率
- 可调输出电压范围为 0.6V 至 4V
- 可实现轻负载效率的省电模式
- 可实现最低压降的 100% 占空比
- 有源输出放电
- 电源正常输出
- 热关断保护
- 断续短路保护
- 强制 PWM 版本可支持 CCM 运行
- 使用 TPS6282x 并借助 WEBENCH® 电源设计器创建定制设计方案

## 2 应用

- 固态硬盘
- 便携式电子产品
- 模拟安防摄像头和 IP 网络摄像头
- 工业 PC
- 多功能打印机
- 通用负载点



典型应用原理图

## 3 说明

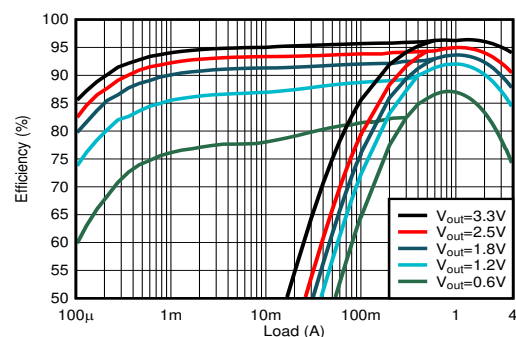
TPS6282x 是一个易于使用的同步降压直流/直流转换器系列，具有仅 4μA 的超低静态电流。该产品基于 DCS-Control 拓扑，可提供快速瞬态响应。由于具有内部基准，该产品可在 -40°C 至 125°C 的结温范围内以 1% 的高反馈电压精度将输出电压调节到 0.6V 以下。该系列器件具有引脚对引脚和 BOM 对 BOM 兼容性。整个解决方案需要一个小型 470nH 电感器、一个 4.7μF 输入电容器和两个 10μF 或一个 22μF 的输出电容器。

TPS6282x 具有两种型号。第一种型号可自动进入省电模式，在超轻负载条件下保持高效率，从而延长系统电池的运行时间。第二种型号可实现强制 PWM 运行，以维持连续导通模式，从而确保超低的输出电压纹波和准固定开关频率。该器件可提供电源正常信号和内部软启动电路。它们能够以 100% 模式运行。在故障保护方面，该系列器件加入了断续短路保护以及热关断功能。该器件可采用 6 引脚 1.5 x 1.5mm QFN 封装，提供具有最高功率密度的解决方案。

### 器件信息

| 器件型号      | 封装 <sup>(1)</sup> | 封装尺寸（标称值）     |
|-----------|-------------------|---------------|
| TPS62824x | 6 引脚 VSON-HR      | 1.5mm x 1.5mm |
| TPS62825x |                   |               |
| TPS62826x |                   |               |
| TPS62827x |                   |               |

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。



V<sub>IN</sub> = 5V 时的效率



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## 4 Revision History

| <b>Changes from Revision E (December 2020) to Revision F (September 2021)</b> | <b>Page</b> |
|-------------------------------------------------------------------------------|-------------|
| • Changed the status of the TPS62824DMQ to Production Data.....               | 3           |
| • Added the TPS6282533.....                                                   | 3           |
| <b>Changes from Revision D (October 2020) to Revision E (December 2020)</b>   | <b>Page</b> |
| • 将 TPS62825A 和 TPS62826A 的器件状态从“预告信息”更改为“量产数据”.....                          | 1           |
| • 向数据表添加了 TPS62824A 和 TPS62827A.....                                          | 1           |
| • Added TPS62824DMQ device option.....                                        | 3           |
| • Added switching frequency curves of TPS62827A .....                         | 14          |

## 5 Device Options

| PART NUMBER   | OUTPUT VOLTAGE | OPERATION MODE | OUTPUT CURRENT |
|---------------|----------------|----------------|----------------|
| TPS62824DMQ   | Adjustable     | PSM/PWM        | 1A             |
| TPS62825DMQ   | Adjustable     |                | 2 A            |
| TPS6282518DMQ | 1.8 V          |                |                |
| TPS6282533DMQ | 3.3 V          |                | 3 A            |
| TPS62826DMQ   | Adjustable     |                |                |
| TPS6282618DMQ | 1.8 V          |                |                |
| TPS62827DMQ   | Adjustable     |                | 4 A            |
| TPS62824ADMQ  | Adjustable     | Forced-PWM     | 1 A            |
| TPS62825ADMQ  | Adjustable     |                | 2 A            |
| TPS62826ADMQ  | Adjustable     |                | 3 A            |
| TPS62827ADMQ  | Adjustable     |                | 4A             |

## 6 Pin Configuration and Functions

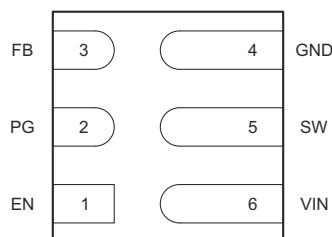


图 6-1. DMQ Package 6-Pin VSON-HR Bottom View

表 6-1. Pin Functions

| PIN  |     | I/O | DESCRIPTION                                                                                                                                 |
|------|-----|-----|---------------------------------------------------------------------------------------------------------------------------------------------|
| NAME | NO. |     |                                                                                                                                             |
| EN   | 1   | I   | Device enable pin. To enable the device, this pin needs to be pulled high. Pulling this pin low disables the device. Do not leave floating. |
| PG   | 2   | O   | Power good open-drain output pin. The pullup resistor can be connected to voltages up to 5.5 V. If unused, leave it floating.               |
| FB   | 3   | I   | Feedback pin. For the fixed output voltage versions, this pin must be connected to the output.                                              |
| GND  | 4   |     | Ground pin                                                                                                                                  |
| SW   | 5   | PWR | Switch pin of the power stage                                                                                                               |
| VIN  | 6   | PWR | Input voltage pin                                                                                                                           |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

|                                |                                                | MIN  | MAX                   | UNIT |
|--------------------------------|------------------------------------------------|------|-----------------------|------|
| Voltage at Pins <sup>(1)</sup> | VIN, FB, EN, PG                                | –0.3 | 6                     | V    |
|                                | SW (DC)                                        | –0.3 | V <sub>IN</sub> + 0.3 |      |
|                                | SW (DC, in current limit)                      | –1.0 | V <sub>IN</sub> + 0.3 |      |
|                                | SW (AC, less than 10ns) <sup>(2)</sup>         | –2.5 | 10                    |      |
| Temperature                    | Operating junction temperature, T <sub>J</sub> | –40  | 150                   | °C   |
|                                | Storage temperature, T <sub>stg</sub>          | –65  | 150                   |      |

(1) All voltage values are with respect to network ground terminal.

(2) While switching.

### 7.2 ESD Ratings

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  | V    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

Over operating junction temperature range (unless otherwise noted)

|                      |                                                         | MIN | NOM | MAX | UNIT |
|----------------------|---------------------------------------------------------|-----|-----|-----|------|
| V <sub>IN</sub>      | Input voltage range, TPS62824x, TPS62825x and TPS62826x | 2.4 |     | 5.5 | V    |
| V <sub>IN</sub>      | Input voltage range, TPS62827x                          | 2.5 |     | 5.5 | V    |
| V <sub>OUT</sub>     | Output voltage range                                    | 0.6 |     | 4.0 | V    |
| I <sub>OUT</sub>     | Output current range, TPS62824x                         | 0   |     | 1   | A    |
| I <sub>OUT</sub>     | Output current range, TPS62825x                         | 0   |     | 2   | A    |
| I <sub>OUT</sub>     | Output current range, TPS62826x                         | 0   |     | 3   | A    |
| I <sub>OUT</sub>     | Output current range, TPS62827x                         | 0   |     | 4   | A    |
| I <sub>SINK_PG</sub> | Sink current at PG pin                                  |     |     | 1   | mA   |
| V <sub>PG</sub>      | Pull-up resistor voltage                                |     |     | 5.5 | V    |
| T <sub>J</sub>       | Operating junction temperature                          | –40 |     | 125 | °C   |

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPS6282xx       |                    | UNIT |
|-------------------------------|----------------------------------------------|-----------------|--------------------|------|
|                               |                                              | TPS6282x, JEDEC | TPS62826EVM-794    |      |
|                               |                                              | 6 PINS          | 6 PINS             |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 129.5           | 71.4               | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 103.9           | n/a <sup>(2)</sup> | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 33.1            | n/a <sup>(2)</sup> | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 3.8             | 3.9                | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 33.1            | 38.6               | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

(2) Not applicable to an EVM.

### 7.5 Electrical Characteristics

T<sub>J</sub> = –40°C to 125°C, and V<sub>IN</sub> = 2.4 V to 5.5 V. Typical values are at T<sub>J</sub> = 25°C and V<sub>IN</sub> = 5 V, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|-----------------|-----|-----|-----|------|
| SUPPLY    |                 |     |     |     |      |

$T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , and  $V_{IN} = 2.4\text{ V}$  to  $5.5\text{ V}$ . Typical values are at  $T_J = 25^{\circ}\text{C}$  and  $V_{IN} = 5\text{ V}$ , unless otherwise noted.

| PARAMETER  |                                   | TEST CONDITIONS                                               | MIN | TYP  | MAX | UNIT               |
|------------|-----------------------------------|---------------------------------------------------------------|-----|------|-----|--------------------|
| $I_Q$      | Quiescent current                 | EN = High, no load, device not switching                      |     | 4    | 10  | $\mu\text{A}$      |
| $I_Q$      | Quiescent current                 | EN = High, no load, FPWM devices                              |     | 8    |     | mA                 |
| $I_{SD}$   | Shutdown current                  | EN = Low, $T_J = -40^{\circ}\text{C}$ to $85^{\circ}\text{C}$ |     | 0.05 | 0.5 | $\mu\text{A}$      |
| $V_{UVLO}$ | Under voltage lock out threshold  | $V_{IN}$ falling                                              | 2.1 | 2.2  | 2.3 | V                  |
|            | Under voltage lock out hysteresis | $V_{IN}$ rising                                               |     | 160  |     | mV                 |
| $T_{JSD}$  | Thermal shutdown threshold        | $T_J$ rising                                                  |     | 150  |     | $^{\circ}\text{C}$ |
|            | Thermal shutdown hysteresis       | $T_J$ falling                                                 |     | 20   |     | $^{\circ}\text{C}$ |

**LOGIC INTERFACE EN**

|              |                                   |           |     |      |     |               |
|--------------|-----------------------------------|-----------|-----|------|-----|---------------|
| $V_{IH}$     | High-level threshold voltage      |           | 1.0 |      |     | V             |
| $V_{IL}$     | Low-level threshold voltage       |           |     |      | 0.4 | V             |
| $I_{EN,LKG}$ | Input leakage current into EN pin | EN = High |     | 0.01 | 0.1 | $\mu\text{A}$ |

**SOFT START, POWER GOOD**

|              |                                   |                                                                   |     |      |     |               |
|--------------|-----------------------------------|-------------------------------------------------------------------|-----|------|-----|---------------|
| $t_{SS}$     | Soft start time                   | Time from EN high to 95% of $V_{OUT}$ nominal, TPS62827           |     | 1.75 |     | ms            |
|              |                                   | Time from EN high to 95% of $V_{OUT}$ nominal, TPS62824x/5x/6x/7A |     | 1.25 |     | ms            |
| $V_{PG}$     | Power good lower threshold        | $V_{PG}$ rising, $V_{FB}$ referenced to $V_{FB}$ nominal          | 94  | 96   | 98  | %             |
|              |                                   | $V_{PG}$ falling, $V_{FB}$ referenced to $V_{FB}$ nominal         | 90  | 92   | 94  | %             |
|              | Power good upper threshold        | $V_{PG}$ rising, $V_{FB}$ referenced to $V_{FB}$ nominal          | 103 | 105  | 107 | %             |
|              |                                   | $V_{PG}$ falling, $V_{FB}$ referenced to $V_{FB}$ nominal         | 108 | 110  | 112 | %             |
| $V_{PG,OL}$  | Low-level output voltage          | $I_{sink} = 1\text{ mA}$                                          |     |      | 0.4 | V             |
| $I_{PG,LKG}$ | Input leakage current into PG pin | $V_{PG} = 5.0\text{ V}$                                           |     | 0.01 | 0.1 | $\mu\text{A}$ |
| $t_{PG,DLY}$ | Power good deglitch delay         | PG rising edge                                                    |     | 100  |     | $\mu\text{s}$ |
|              |                                   | PG falling edge                                                   |     | 20   |     |               |

**OUTPUT**

|              |                                                                         |                                                                     |       |      |       |               |
|--------------|-------------------------------------------------------------------------|---------------------------------------------------------------------|-------|------|-------|---------------|
| $V_{OUT}$    | Output voltage accuracy                                                 | TPS6282533, PWM mode                                                | 3.267 | 3.3  | 3.333 | V             |
| $V_{OUT}$    | Output voltage accuracy                                                 | TPS6282x18, PWM mode                                                | 1.78  | 1.8  | 1.82  | V             |
| $V_{FB}$     | Feedback regulation voltage                                             | PWM mode                                                            | 594   | 600  | 606   | mV            |
| $I_{FB,LKG}$ | Feedback input leakage current for adjustable output voltage            | $V_{FB} = 0.6\text{ V}$                                             |       | 0.01 | 0.05  | $\mu\text{A}$ |
| $R_{FB}$     | Internal resistor divider connected to FB pin, for fixed output voltage | TPS6282518, TPS6282618, TPS6282533                                  |       | 7.5  |       | M $\Omega$    |
| $I_{DIS}$    | Output discharge current                                                | $V_{SW} = 0.4\text{V}$ ; EN = LOW                                   | 75    | 400  |       | mA            |
|              | Load regulation                                                         | $I_{OUT} = 0.5\text{ A}$ to $3\text{ A}$ , $V_{OUT} = 1.8\text{ V}$ |       | 0.1  |       | %/A           |

**POWER SWITCH**

|              |                                         |                                                   |     |      |     |            |
|--------------|-----------------------------------------|---------------------------------------------------|-----|------|-----|------------|
| $R_{DS(on)}$ | High-side FET on-resistance             |                                                   |     | 26   |     | m $\Omega$ |
|              | Low-side FET on-resistance              |                                                   |     | 25   |     | m $\Omega$ |
| $I_{LIM}$    | High-side FET switch current limit, DC  | TPS62824A                                         | 1.7 | 2.1  | 2.4 | A          |
|              |                                         | TPS62825x                                         | 2.7 | 3.3  | 3.9 | A          |
|              |                                         | TPS62826x                                         | 3.7 | 4.3  | 5.0 | A          |
|              |                                         | TPS62827x                                         | 4.8 | 5.6  | 6.4 | A          |
| $I_{LIM}$    | Low-side FET negative current limit, DC | TPS62824A/5A/6A/7A                                |     | -1.6 |     | A          |
| $f_{SW}$     | PWM switching frequency                 | $I_{OUT} = 1\text{ A}$ , $V_{OUT} = 1.8\text{ V}$ |     | 2.2  |     | MHz        |

## 7.6 Typical Characteristics

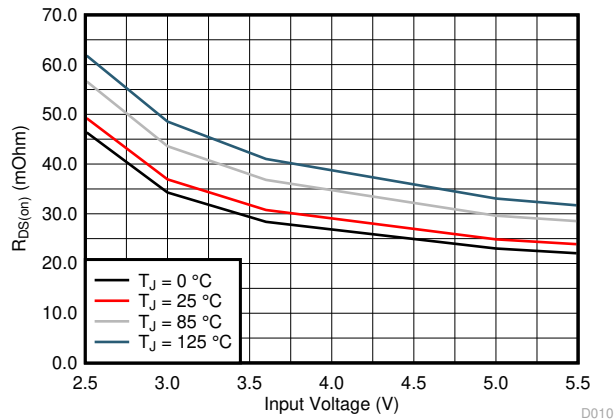


图 7-1. High-Side FET On-Resistance

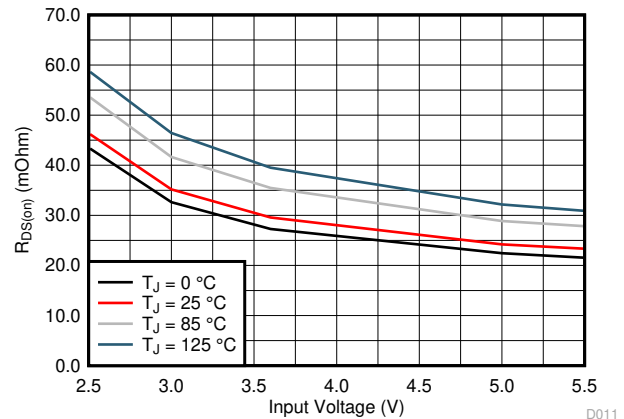


图 7-2. Low-Side FET On-Resistance

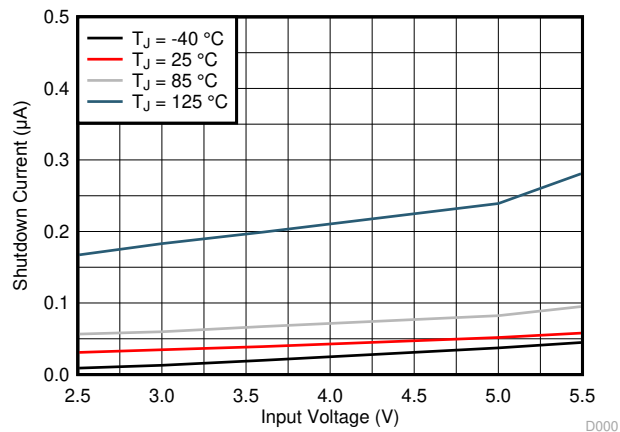


图 7-3. Shutdown Current

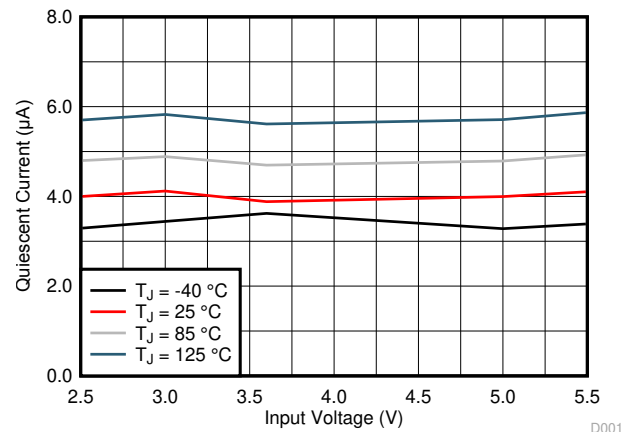


图 7-4. Quiescent Current

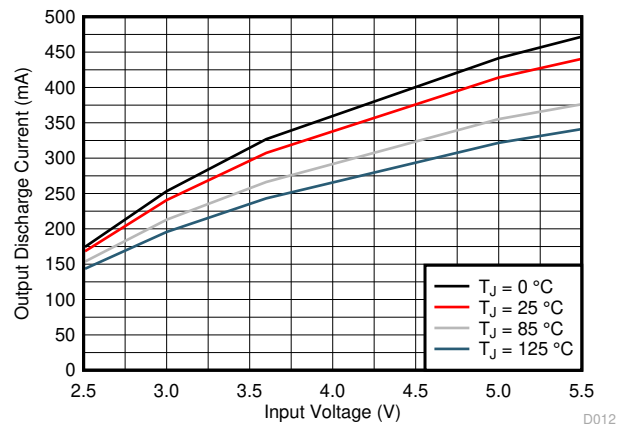


图 7-5. Output Discharge Current



## 8.3 Feature Description

### 8.3.1 Pulse Width Modulation (PWM) Operation

At load currents larger than half the inductor ripple current, the device operates in pulse width modulation in continuous conduction mode (CCM). The PWM operation is based on an adaptive constant on-time control with stabilized switching frequency. To achieve a stable switching frequency in a steady state condition, the on-time is calculated as:

$$T_{ON} = \frac{V_{OUT}}{V_{IN}} \cdot 450ns \quad (1)$$

In forced-PWM devices, the device always operates in pulse width modulation in continuous conduction mode (CCM).

### 8.3.2 Power Save Mode (PSM) Operation

To maintain high efficiency at light loads, the device enters power save mode (PSM) at the boundary to discontinuous conduction mode (DCM). This happens when the output current becomes smaller than half of the ripple current of the inductor. The device operates now with a fixed on-time and the switching frequency further decreases proportional to the load current. It can be calculated as:

$$f_{PSM} = \frac{2 \cdot I_{OUT}}{T_{ON}^2 \cdot \frac{V_{IN}}{V_{OUT}} \left[ \frac{V_{IN} - V_{OUT}}{L} \right]} \quad (2)$$

In PSM, the output voltage rises slightly above the nominal target, which can be minimized using larger output capacitance. At duty cycles larger than 90%, the device may not enter PSM. The device maintains output regulation in PWM mode.

### 8.3.3 Minimum Duty Cycle and 100% Mode Operation

There is no limitation for small duty cycles since even at very low duty cycles, the switching frequency is reduced as needed to always ensure a proper regulation.

If the output voltage level comes close to the input voltage, the device enters 100% mode. While the high-side switch is constantly turned on, the low-side switch is switched off. The difference between VIN and VOUT is determined by the voltage drop across the high-side FET and the DC resistance of the inductor. The minimum VIN that is needed to maintain a specific VOUT value is estimated as:

$$V_{IN,MIN} = V_{OUT} + I_{OUT,MAX} \times (R_{DS(on)} + R_L) \quad (3)$$

where

- $V_{IN,MIN}$  = Minimum input voltage to maintain an output voltage
- $I_{OUT,MAX}$  = Maximum output current
- $R_{DS(on)}$  = High-side FET ON-resistance
- $R_L$  = Inductor ohmic resistance (DCR)

### 8.3.4 Soft Start

About 250  $\mu$ s after EN goes High, the internal soft-start circuitry controls the output voltage during start-up. This avoids excessive inrush current and ensures a controlled output voltage ramp. It also prevents unwanted voltage drops from high-impedance power sources or batteries. The TPS6282x can start into a pre-biased output.

### 8.3.5 Switch Current Limit and HICCUP Short-Circuit Protection

The switch current limit prevents the device from drawing excessive current in case of externally-caused overcurrent or short circuit condition. Due to an internal propagation delay (typically 60 ns), the actual AC peak current can exceed the static current limit during that time.

If the current limit threshold is reached, the device delivers its maximum output current. Detecting this condition for 32 switching cycles (about 13  $\mu$ s), the device turns off the high-side MOSFET for about 100  $\mu$ s which allows the inductor current to decrease through the low-side MOSFET's body diode and then restarts again with a soft start cycle. As long as the overload condition is present, the device hiccups that way, limiting the output power.

In forced PWM devices, a negative current limit ( $I_{LIMN}$ ) is enabled to prevent excessive current flowing backwards to the input. When the inductor current reaches  $I_{LIMN}$ , the low-side MOSFET turns off and the high-side MOSFET turns on and kept on until  $T_{ON}$  time expires.

### 8.3.6 Undervoltage Lockout

The undervoltage lockout (UVLO) function prevents misoperation of the device if the input voltage drops below the UVLO threshold. It is set to about 2.2 V with a hysteresis of typically 160 mV.

### 8.3.7 Thermal Shutdown

The junction temperature ( $T_J$ ) of the device is monitored by an internal temperature sensor. If  $T_J$  exceeds 150°C (typ.), the device goes in thermal shutdown with a hysteresis of typically 20°C. Once  $T_J$  has decreased enough, the device resumes normal operation.

## 8.4 Device Functional Modes

### 8.4.1 Enable, Disable, and Output Discharge

The device starts operation when Enable (EN) is set High. The input threshold levels are typically 0.9 V for rising and 0.7 V for falling signals. Do not leave EN floating. Shutdown is forced if EN is pulled Low with a shutdown current of typically 50 nA. During shutdown, the internal power MOSFETs as well as the entire control circuitry are turned off and the output voltage is actively discharged through the SW pin by a current sink. Therefore VIN must remain present for the discharge to function.

### 8.4.2 Power Good

The TPS6282x has a built-in power good (PG) function. The PG pin goes high impedance when the output voltage has reached its nominal value. Otherwise, including when disabled, in UVLO or in thermal shutdown, PG is Low (see 表 8-1). The PG function is formed with a window comparator, which has an upper and lower voltage threshold. The PG pin is an open-drain output and is specified to sink up to 1 mA. The power good output requires a pullup resistor connecting to any voltage rail less than 5.5 V.

The PG signal can be used for sequencing of multiple rails by connecting it to the EN pin of other converters. Leave the PG pin unconnected when not used. The PG rising edge has a 100- $\mu$ s blanking time and the PG falling edge has a deglitch delay of 20  $\mu$ s.

**表 8-1. PG Pin Logic**

| DEVICE CONDITIONS    |                                  | LOGIC STATUS |     |
|----------------------|----------------------------------|--------------|-----|
|                      |                                  | HIGH Z       | LOW |
| Enable               | EN = High, $V_{FB} \geq 0.576$ V | √            |     |
|                      | EN = High, $V_{FB} \leq 0.552$ V |              | √   |
|                      | EN = High, $V_{FB} \leq 0.63$ V  | √            |     |
|                      | EN = High, $V_{FB} \geq 0.66$ V  |              | √   |
| Shutdown             | EN = Low                         |              | √   |
| Thermal Shutdown     | $T_J > T_{JSD}$                  |              | √   |
| UVLO                 | $0.7$ V < $V_{IN}$ < $V_{UVLO}$  |              | √   |
| Power Supply Removal | $V_{IN} < 0.7$ V                 | √            |     |

## 9 Application and Implementation

### Note

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

### 9.1 Application Information

The following section discusses the design of the external components to complete the power supply design for several input and output voltage options by using typical applications as a reference.

### 9.2 Typical Application

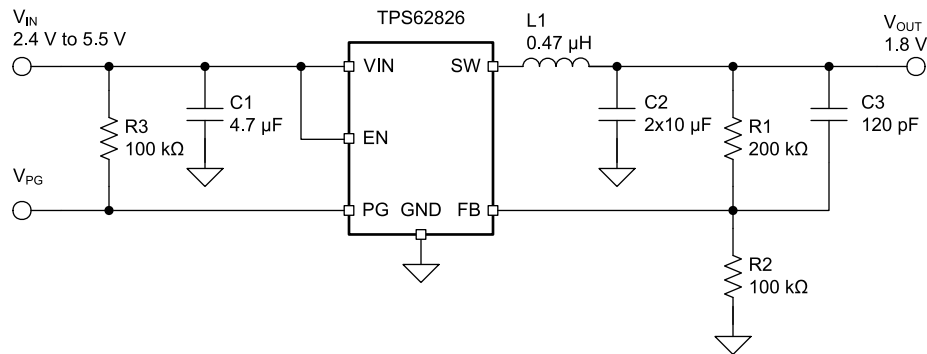


图 9-1. Typical Application of TPS62826x

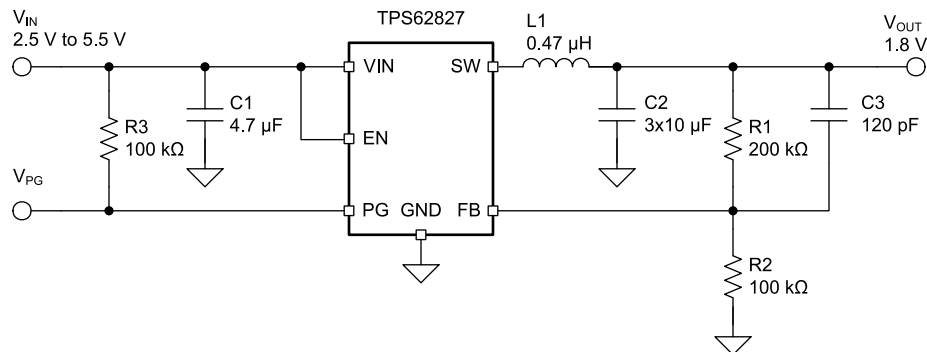


图 9-2. Typical Application of TPS62827

#### 9.2.1 Design Requirements

For this design example, use the parameters listed in 表 9-1 as the input parameters.

表 9-1. Design Parameters

| DESIGN PARAMETER                  | EXAMPLE VALUE  |
|-----------------------------------|----------------|
| Input voltage, TPS62826x          | 2.4 V to 5.5 V |
| Input voltage, TPS62827x          | 2.5 V to 5.5 V |
| Output voltage                    | 1.8 V          |
| Output ripple voltage             | <20 mV         |
| Maximum output current, TPS62826x | 3 A            |
| Maximum output current, TPS62827x | 4 A            |

表 9-2 lists the components used for the example.

**表 9-2. List of Components**

| REFERENCE                 | DESCRIPTION                                                                 | MANUFACTURER |
|---------------------------|-----------------------------------------------------------------------------|--------------|
| C1                        | 4.7 $\mu$ F, Ceramic capacitor, 6.3 V, X7R, size 0603, JMK107BB7475MA       | Taiyo Yuden  |
| C2,<br>TPS62824x/5x/6x/7A | 2 x 10 $\mu$ F, Ceramic capacitor, 10 V, X7R, size 0603, GRM188Z71A106MA73D | Murata       |
| C2, TPS62827              | 3 x 10 $\mu$ F, Ceramic capacitor, 10 V, X7R, size 0603, GRM188Z71A106MA73D | Murata       |
| C3                        | 120 pF, Ceramic capacitor, 50 V, size 0402                                  | Std          |
| L1                        | 0.47 $\mu$ H, Power Inductor, XFL4015-471MEB                                | Coilcraft    |
| R1                        | Depending on the output voltage, 1%, size 0402                              | Std          |
| R2                        | 100 k $\Omega$ , Chip resistor, 1/16 W, 1%, size 0402                       | Std          |
| R3                        | 100 k $\Omega$ , Chip resistor, 1/16 W, 1%, size 0402                       | Std          |

## 9.2.2 Detailed Design Procedure

### 9.2.2.1 Custom Design With WEBENCH® Tools

[Click here](#) to create a custom design using the TPS6282x device with the WEBENCH® Power Designer.

1. Start by entering the input voltage ( $V_{IN}$ ), output voltage ( $V_{OUT}$ ), and output current ( $I_{OUT}$ ) requirements.
2. Optimize the design for key parameters such as efficiency, footprint, and cost using the optimizer dial.
3. Compare the generated design with other possible solutions from Texas Instruments.

The WEBENCH Power Designer provides a customized schematic along with a list of materials with real-time pricing and component availability.

In most cases, these actions are available:

- Run electrical simulations to see important waveforms and circuit performance
- Run thermal simulations to understand board thermal performance
- Export customized schematic and layout into popular CAD formats
- Print PDF reports for the design, and share the design with colleagues

Get more information about WEBENCH tools at [www.ti.com/WEBENCH](http://www.ti.com/WEBENCH).

### 9.2.2.2 Setting The Output Voltage

The output voltage is set by an external resistor divider according to [方程式 4](#):

$$R1 = R2 \times \left( \frac{V_{OUT}}{V_{FB}} - 1 \right) = R2 \times \left( \frac{V_{OUT}}{0.6V} - 1 \right) \quad (4)$$

R2 must not be higher than 100 k $\Omega$  to achieve high efficiency at light load while providing acceptable noise sensitivity. [方程式 5](#) shows how to compute the value of the feedforward capacitor for a given R2 value. For the recommended 100k value for R2, a 120-pF feedforward capacitor is used.

$$C3 = \frac{12\mu}{R2} \quad (5)$$

For the fixed output voltage versions, connect the FB pin to the output. R1, R2, and C3 are not needed. The fixed output voltage devices have an internal feedforward capacitor.

### 9.2.2.3 Output Filter Design

The inductor and the output capacitor together provide a low-pass filter. To simplify this process, [表 9-3](#) outlines possible inductor and capacitor value combinations for most applications. Checked cells represent combinations that are proven for stability by simulation and lab test. Further combinations should be checked for each individual application.

**表 9-3. Matrix of Output Capacitor and Inductor Combinations, TPS62824x, TPS62825x, TPS62826x and TPS62827A**

| NOMINAL L [ $\mu$ H] <sup>(2)</sup> | NOMINAL C <sub>OUT</sub> [ $\mu$ F] <sup>(3)</sup> |              |    |     |
|-------------------------------------|----------------------------------------------------|--------------|----|-----|
|                                     | 10                                                 | 2 x 10 or 22 | 47 | 100 |
| 0.33                                |                                                    |              |    |     |
| 0.47                                | +                                                  | +(1)         | +  |     |
| 1.0                                 |                                                    |              |    |     |

- (1) This LC combination is the standard value and recommended for most applications.  
(2) Inductor tolerance and current derating is anticipated. The effective inductance can vary by 20% and –30%.  
(3) Capacitance tolerance and bias voltage derating is anticipated. The effective capacitance can vary by 20% and –35%.

**表 9-4. Matrix of Output Capacitor and Inductor Combinations, TPS62827**

| NOMINAL L [ $\mu$ H] <sup>(2)</sup> | NOMINAL C <sub>OUT</sub> [ $\mu$ F] <sup>(3)</sup> |        |    |     |
|-------------------------------------|----------------------------------------------------|--------|----|-----|
|                                     | 22                                                 | 3 x 10 | 47 | 100 |
| 0.33                                |                                                    |        |    |     |
| 0.47                                |                                                    | +(1)   | +  | +   |
| 1.0                                 |                                                    |        |    |     |

#### 9.2.2.4 Inductor Selection

The main parameter for the inductor selection is the inductor value and then the saturation current of the inductor. To calculate the maximum inductor current under static load conditions, 方程式 6 is given.

$$I_{L,MAX} = I_{OUT,MAX} + \frac{\Delta I_L}{2}$$

$$\Delta I_L = V_{OUT} \times \frac{1 - \frac{V_{OUT}}{V_{IN}}}{L \times f_{SW}} \quad (6)$$

where

- $I_{OUT,MAX}$  = Maximum output current
- $\Delta I_L$  = Inductor current ripple
- $f_{SW}$  = Switching frequency
- $L$  = Inductor value

It is recommended to choose a saturation current for the inductor that is approximately 20% to 30% higher than  $I_{L,MAX}$ . In addition, DC resistance and size should also be taken into account when selecting an appropriate inductor. 表 9-5 lists recommended inductors.

表 9-5. List of Recommended Inductors

| INDUCTANCE [μH] | CURRENT RATING [A] | DIMENSIONS [L x W x H mm] | MAX. DC RESISTANCE [mΩ] | MFR PART NUMBER <sup>(1)</sup> |
|-----------------|--------------------|---------------------------|-------------------------|--------------------------------|
| 0.47            | 4.8                | 2.0 x 1.6 x 1.0           | 32                      | HTEN20161T-R47MDR, Cyntec      |
|                 | 4.6                | 2.0 x 1.2 x 1.0           | 25                      | HTEH20121T-R47MSR, Cyntec      |
|                 | 4.8                | 2.0 x 1.6 x 1.0           | 32                      | DFE201610E - R47M, MuRata      |
|                 | 4.8                | 2.0 x 1.6 x 1.0           | 32                      | DFE201210S - R47M, MuRata      |
|                 | 5.1                | 2.0 x 1.6 x 1.0           | 34                      | TFM201610ALM-R47MTAA, TDK      |
|                 | 5.2                | 2.0 x 1.6 x 1.0           | 25                      | TFM201610ALC-R47MTAA, TDK      |
|                 | 6.6                | 4.0 x 4.0 x 1.6           | 8.36                    | XFL4015-471ME, Coilcraft       |
|                 | 8.0                | 3.5 x 3.2 x 2.0           | 10.85                   | XEL3520-471ME, Coilcraft       |
|                 | 6.8                | 4.5 x 4 x 1.8             | 11.2                    | WE-LHMI-744373240047, Würth    |

(1) See the [Third-party Products Disclaimer](#)

### 9.2.2.5 Capacitor Selection

The input capacitor is the low-impedance energy source for the converters which helps provide stable operation. A low-ESR multilayer ceramic capacitor is recommended for best filtering and must be placed between VIN and GND as close as possible to those pins. For most applications, a minimum effective input capacitance of 3 μF should be present, though a larger value reduces input current ripple.

The architecture of the device allows the use of tiny ceramic output capacitors with low equivalent series resistance (ESR). These capacitors provide low output voltage ripple and are recommended. To keep its low resistance up to high frequencies and to get narrow capacitance variation with temperature, TI recommends using X7R or X5R dielectrics. Considering the DC-bias derating the capacitance, the minimum effective output capacitance is 10 μF for TPS62824x, TPS62825x, TPS62826x and TPS62827A and 20 μF for TPS62827.

A feed forward capacitor is required for the adjustable version, as described in [§ 9.2.2.2](#). This capacitor is not required for the fixed output voltage versions.

## 9.2.3 Application Curves

$V_{IN} = 5.0\text{ V}$ ,  $V_{OUT} = 1.8\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , BOM = 表 9-2, unless otherwise noted.

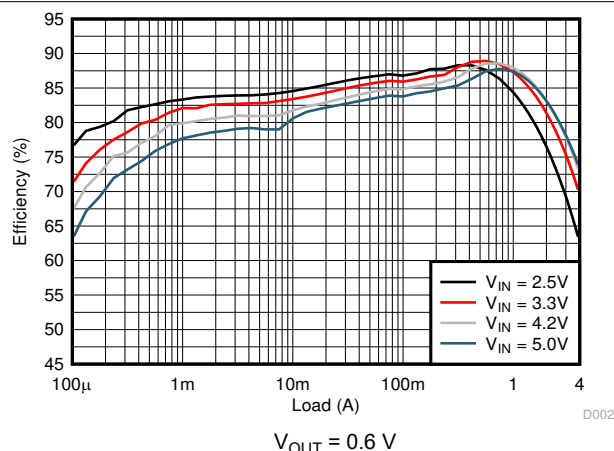


图 9-3. Efficiency

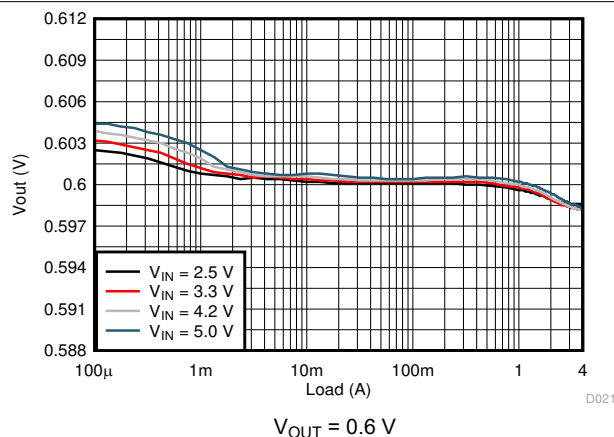


图 9-4. Load Regulation

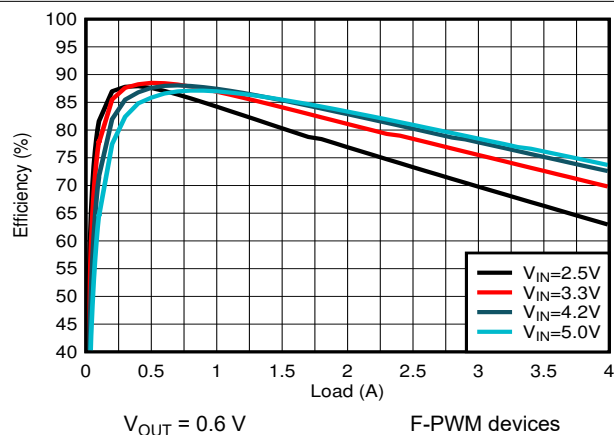


图 9-5. PWM Efficiency

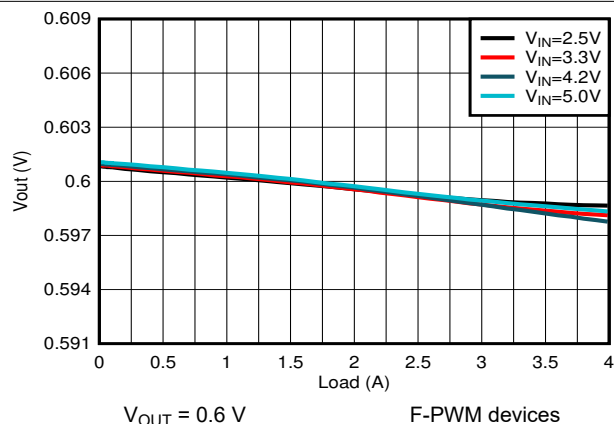


图 9-6. Load Regulation

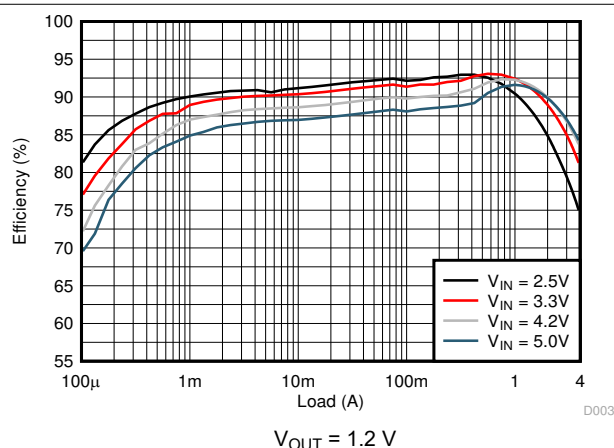


图 9-7. Efficiency

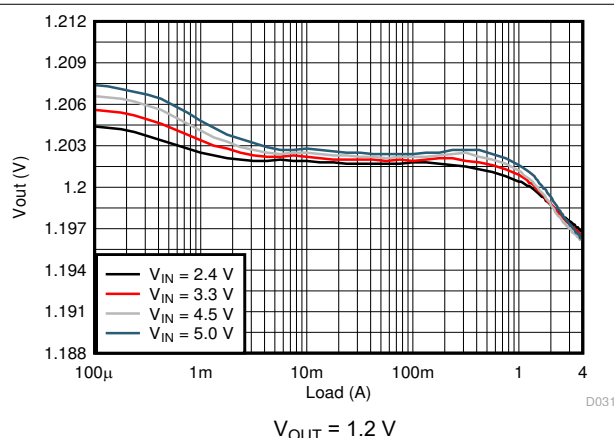
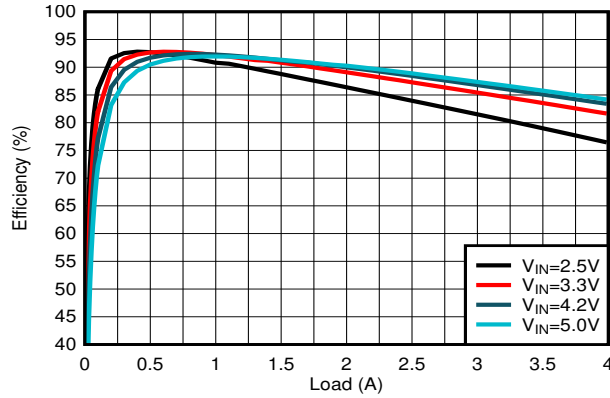
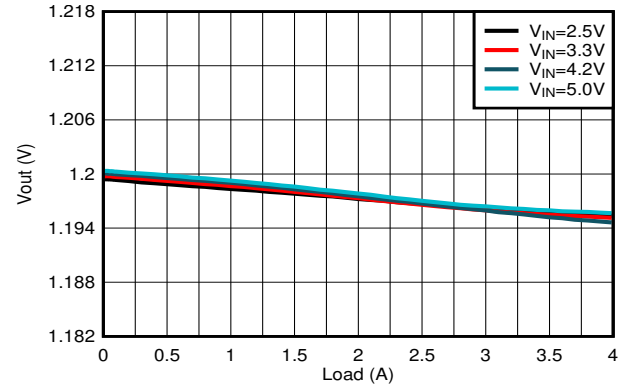


图 9-8. Load Regulation



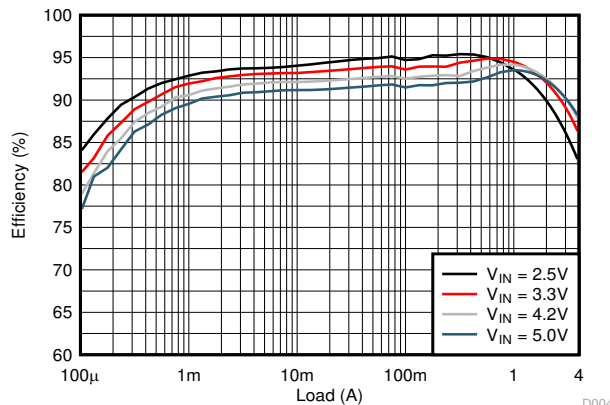
$V_{OUT} = 1.2\text{ V}$  F-PWM devices

图 9-9. PWM Efficiency



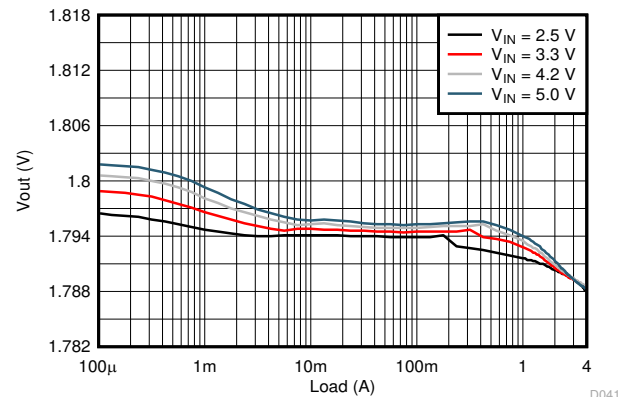
$V_{OUT} = 1.2\text{ V}$  F-PWM devices

图 9-10. Load Regulation



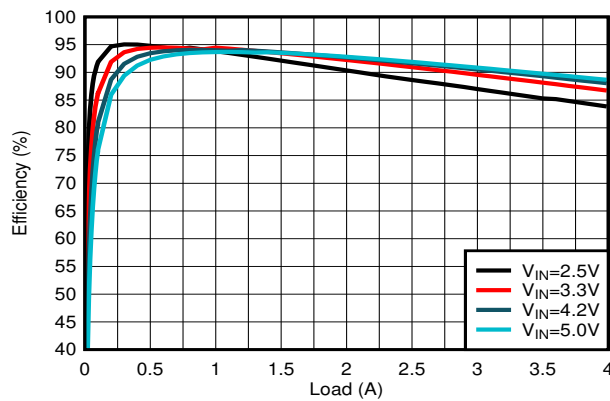
$V_{OUT} = 1.8\text{ V}$

图 9-11. Efficiency



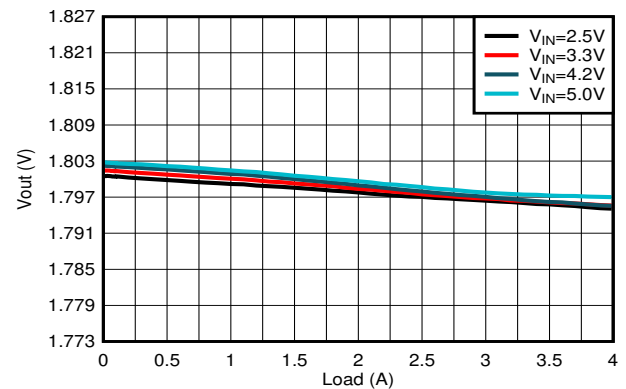
$V_{OUT} = 1.8\text{ V}$

图 9-12. Load Regulation



$V_{OUT} = 1.8\text{ V}$  F-PWM devices

图 9-13. PWM Efficiency



$V_{OUT} = 1.8\text{ V}$  F-PWM devices

图 9-14. Load Regulation

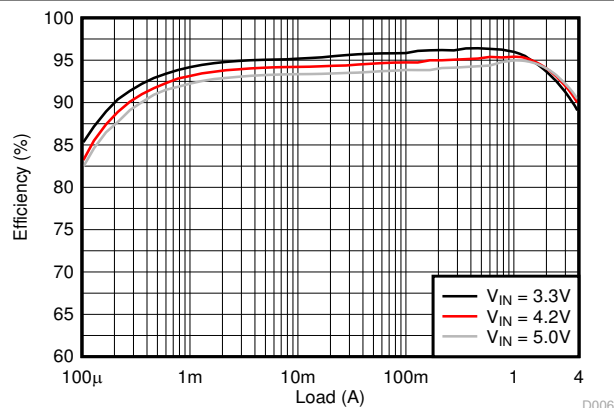


图 9-15. Efficiency

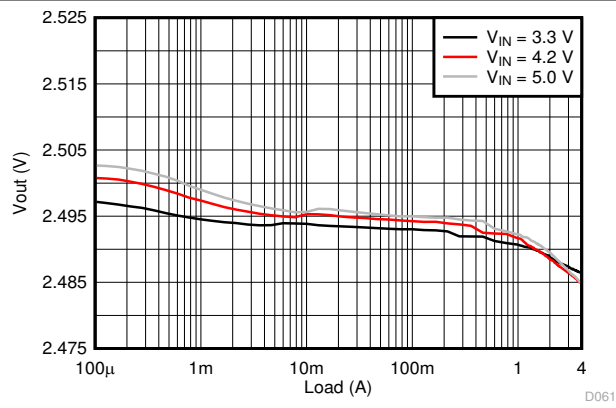


图 9-16. Load Regulation

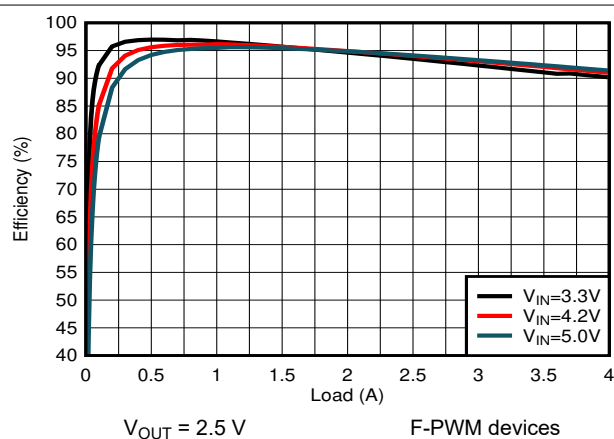


图 9-17. PWM Efficiency

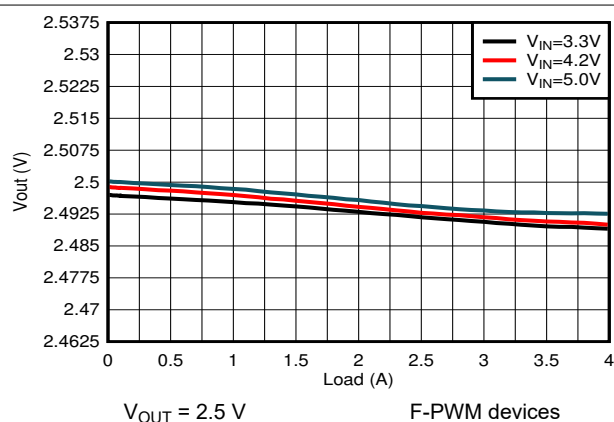


图 9-18. Load Regulation

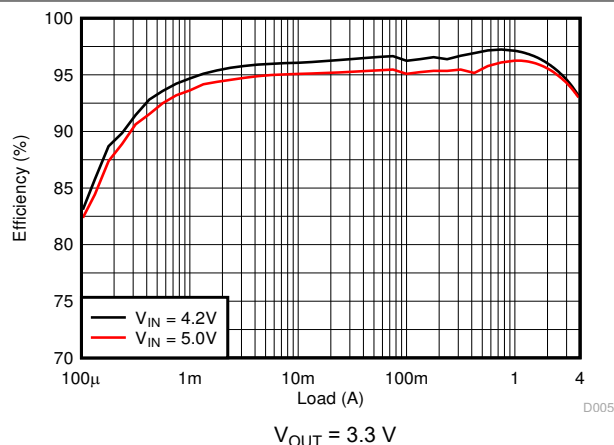


图 9-19. Efficiency

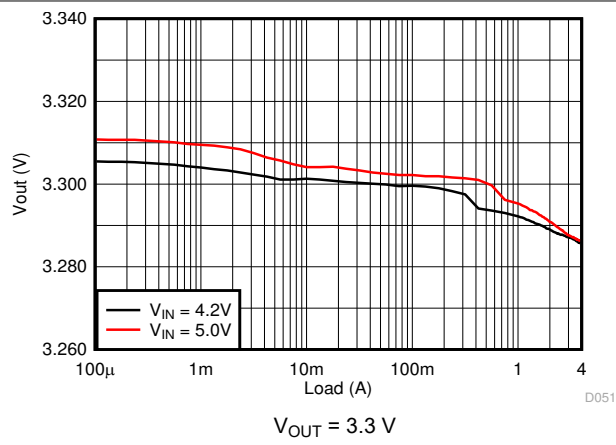
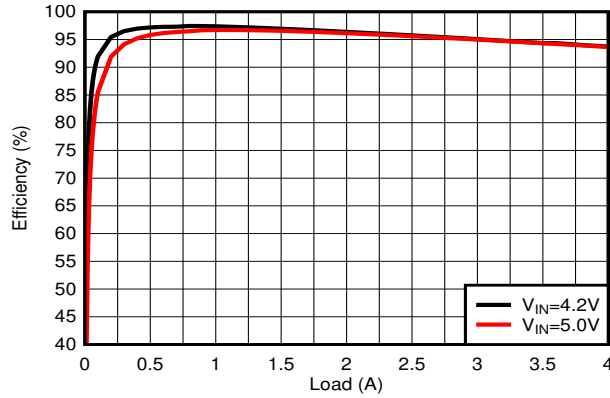
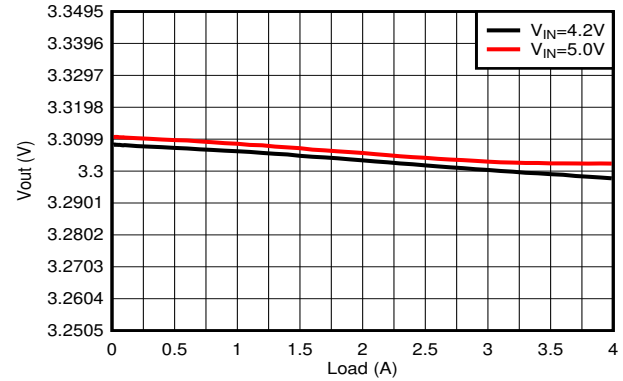


图 9-20. Load Regulation



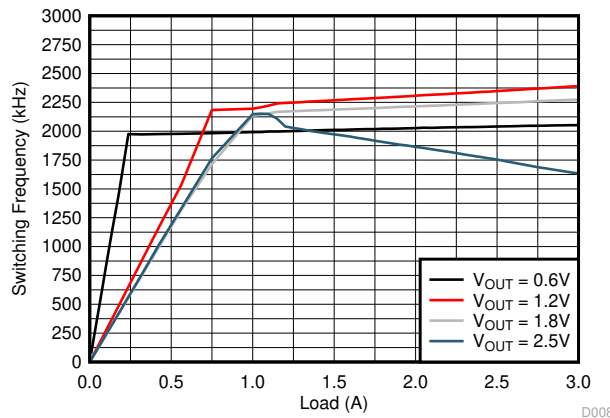
$V_{OUT} = 3.3\text{ V}$  F-PWM devices

图 9-21. PWM Efficiency



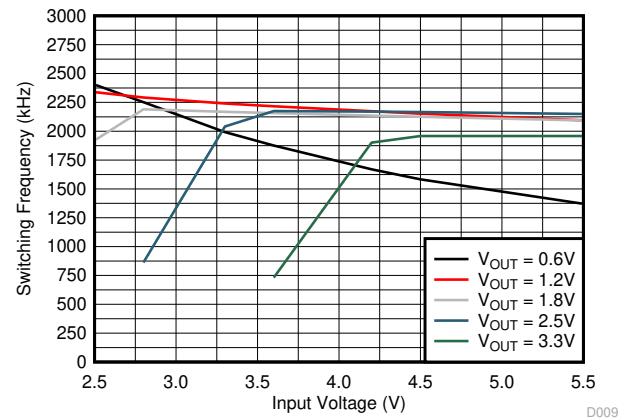
$V_{OUT} = 3.3\text{ V}$  F-PWM devices

图 9-22. Load Regulation



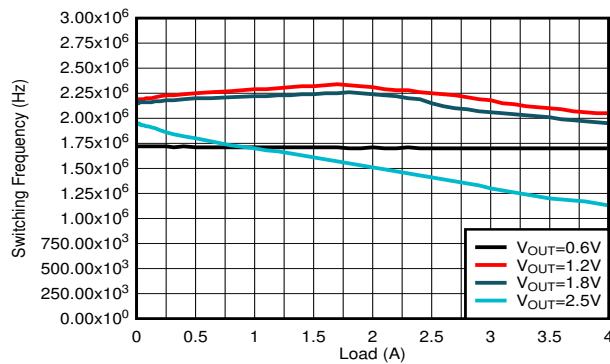
$V_{IN} = 3.3\text{ V}$  TPS62824/5/6

图 9-23. Switching Frequency



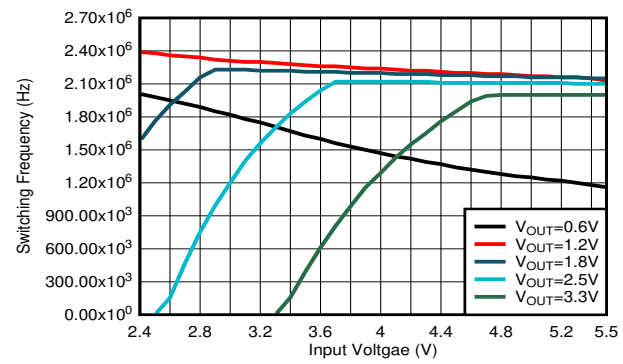
$I_{OUT} = 1.0\text{ A}$  TPS62824/5/6

图 9-24. Switching Frequency



$V_{IN} = 3.3\text{ V}$  TPS62824A/5A/6A/7A

图 9-25. Switching Frequency



$I_{OUT} = 1.0\text{ A}$  TPS62824A/5A/6A/7A

图 9-26. Switching Frequency

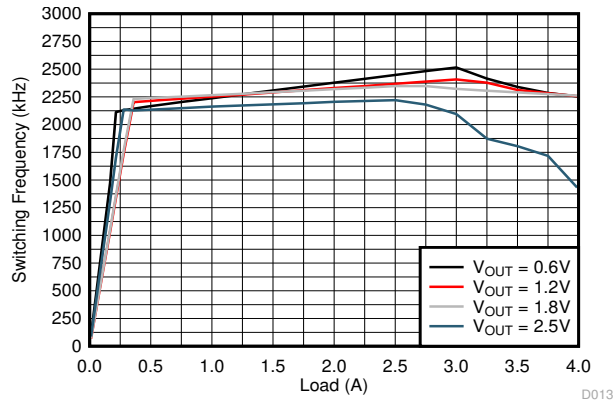


图 9-27. Switching Frequency

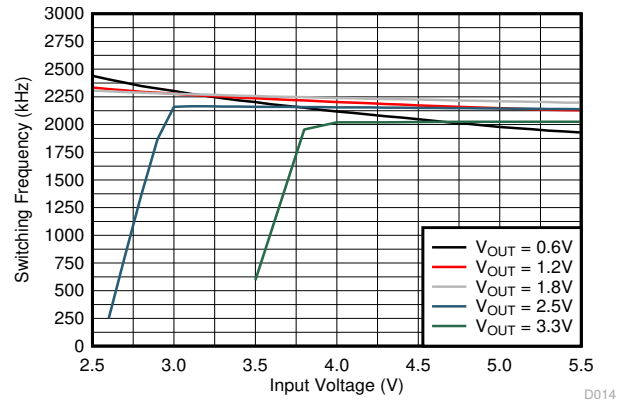


图 9-28. Switching Frequency

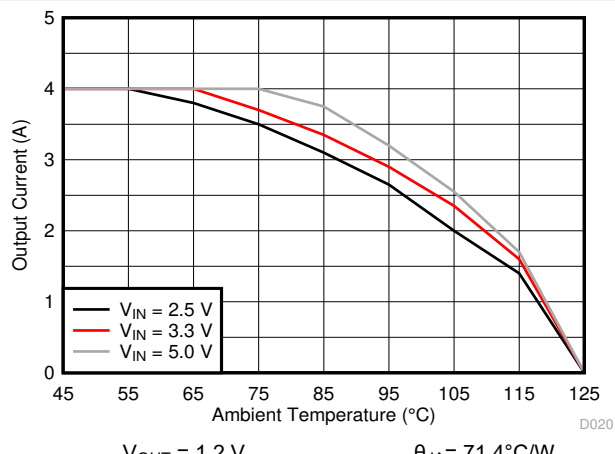


图 9-29. Thermal Derating

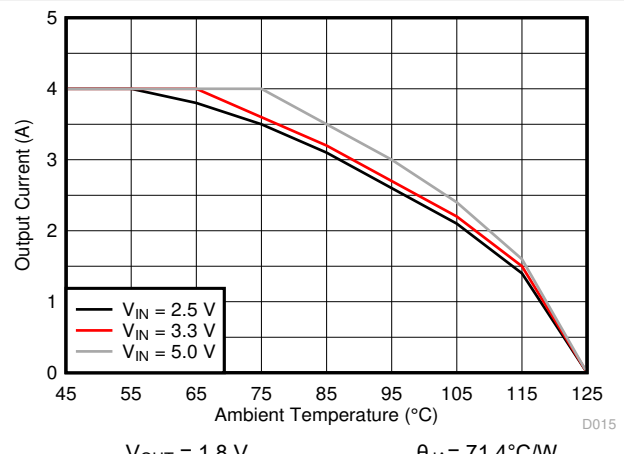


图 9-30. Thermal Derating

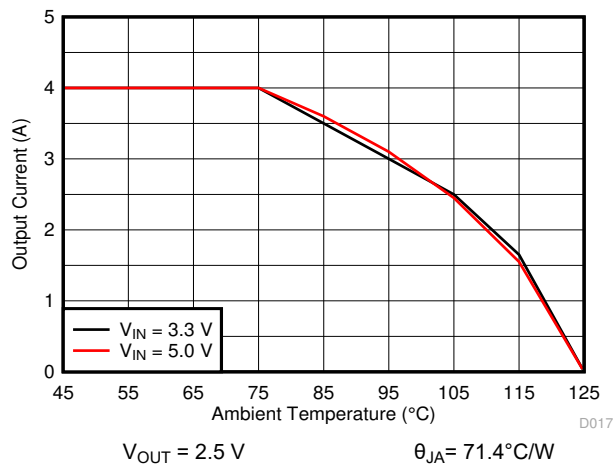


图 9-31. Thermal Derating

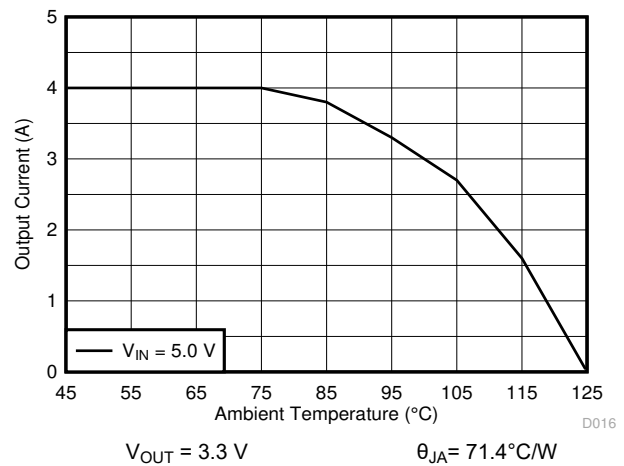
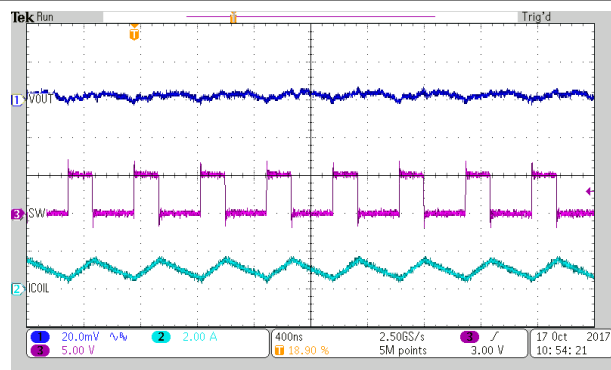
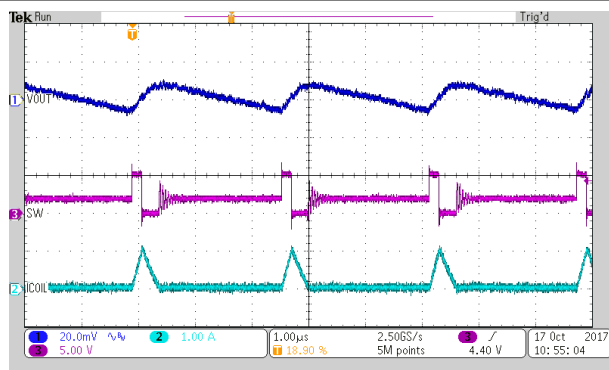


图 9-32. Thermal Derating



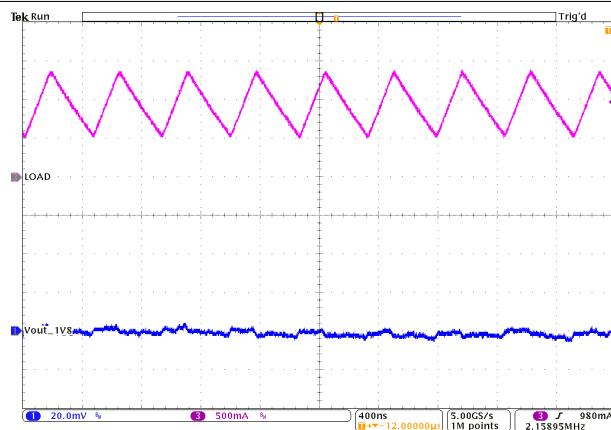
$I_{OUT} = 1.0 \text{ A}$  TPS62824/5/6/7

图 9-33. PWM Operation



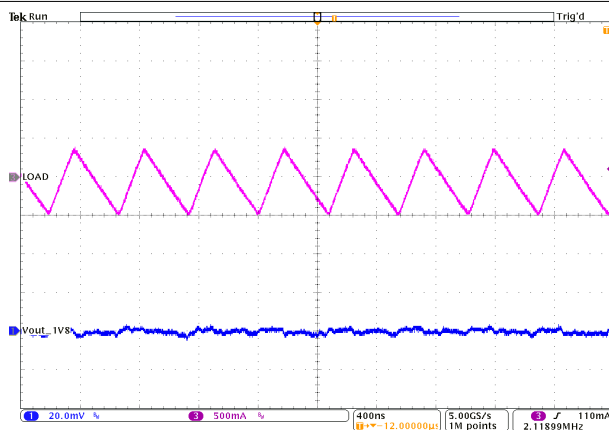
$I_{OUT} = 0.1 \text{ A}$  TPS62824/5/6/7

图 9-34. PSM Operation



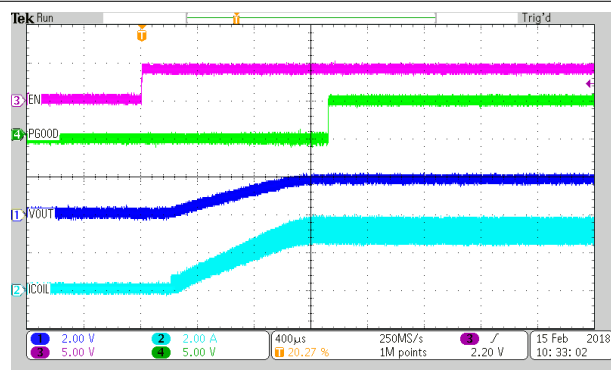
$I_{OUT} = 1.0 \text{ A}$  TPS62824A/5A/6A/7A

图 9-35. PWM Operation at F-PWM



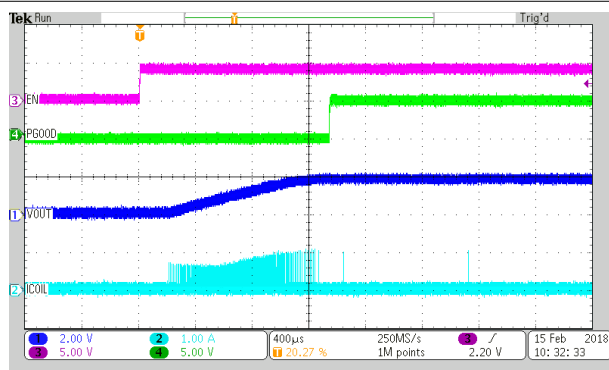
No load TPS62824A/5A/6A/7A

图 9-36. PWM Operation at F-PWM



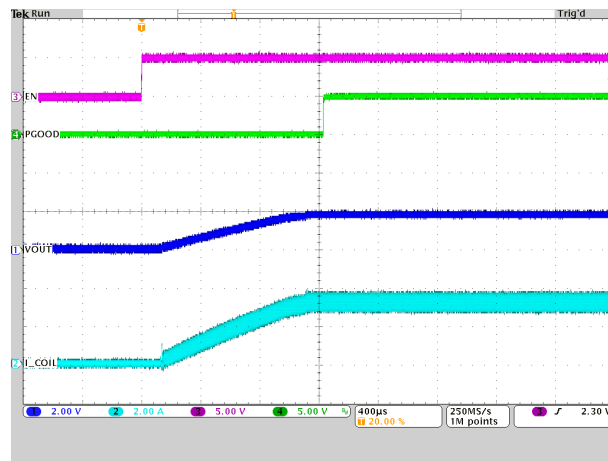
Load = 0.6  $\Omega$  TPS62825/6/7

图 9-37. Start-up with Load



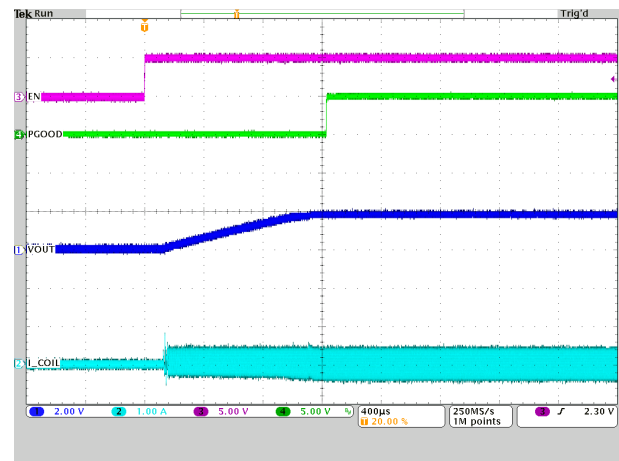
TPS62824/5/6/7

图 9-38. Start-up with No Load



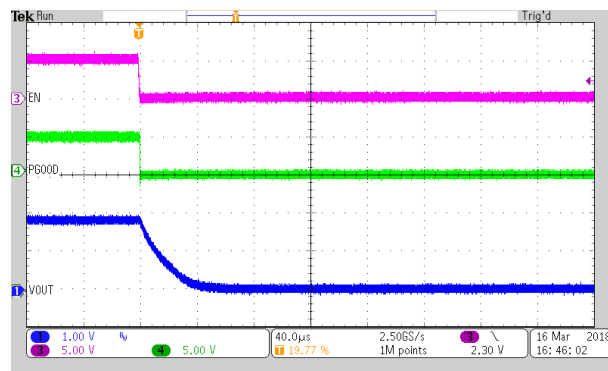
Load = 0.6  $\Omega$  TPS62825A/6A/7A

图 9-39. Start-up with Load



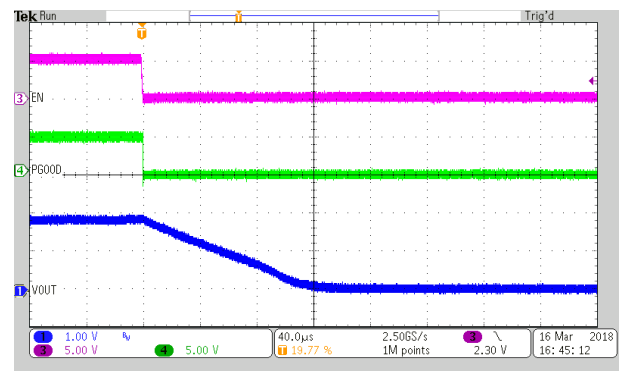
TPS62824A/5A/6A/7A

图 9-40. Start-up with No Load



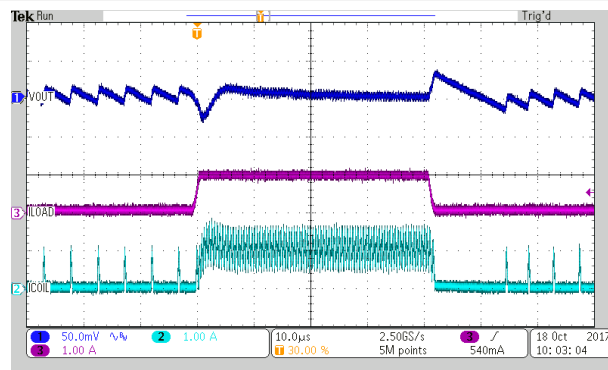
Load = 1.8  $\Omega$  TPS6282x

图 9-41. Disable, Active Output Discharge



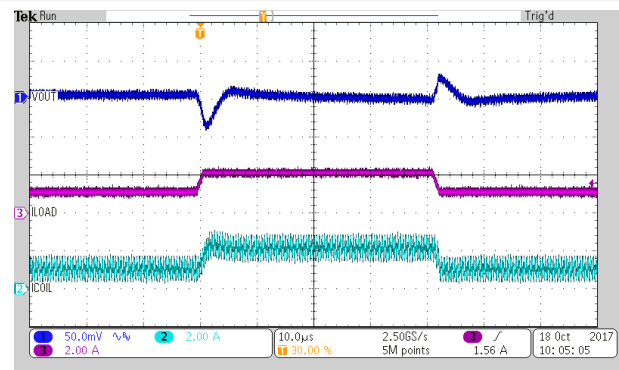
TPS6282x

图 9-42. Disable, Active Output Discharge at No Load



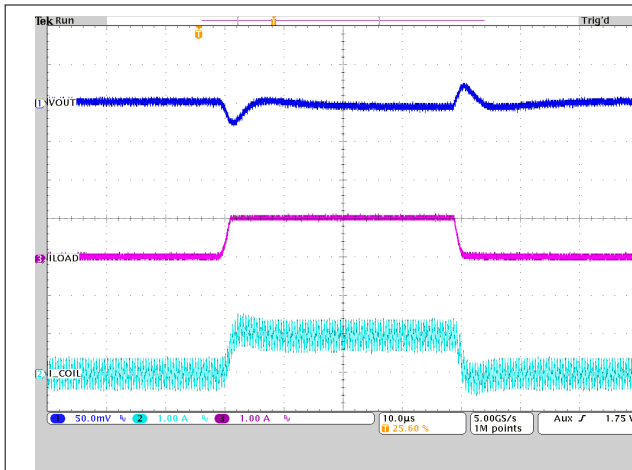
$I_{OUT} = 0.05 \text{ A to } 1 \text{ A}$  TPS62824/5/6/7

图 9-43. Load Transient



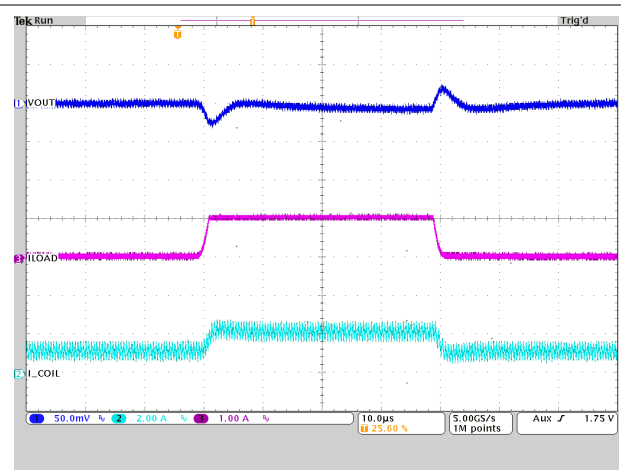
$I_{OUT} = 1 \text{ A to } 2 \text{ A}$  TPS62825/6/7

图 9-44. Load Transient



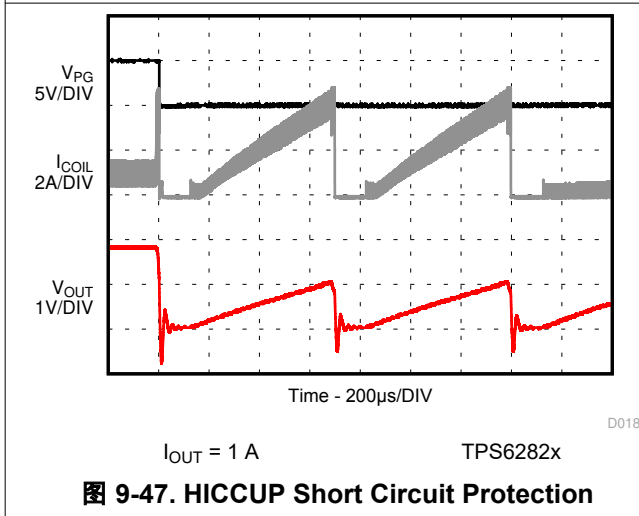
$I_{OUT} = 0.05 \text{ A to } 1 \text{ A}$  TPS62824A/5A/6A/7A

图 9-45. Load Transient



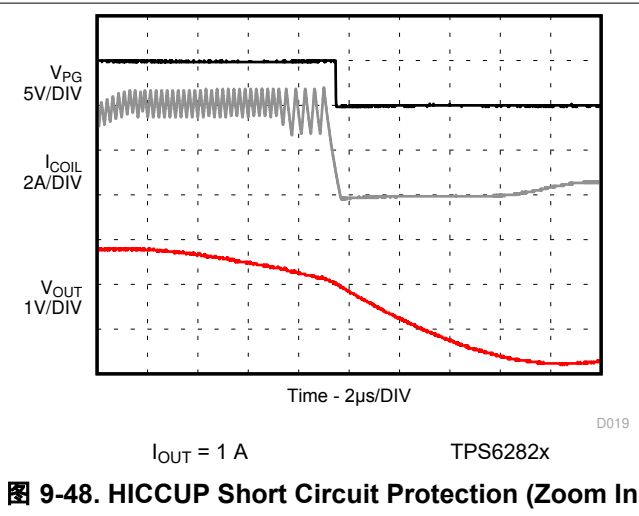
$I_{OUT} = 1 \text{ A to } 2 \text{ A}$  TPS62825A/6A/7A

图 9-46. Load Transient



$I_{OUT} = 1 \text{ A}$  TPS6282x

图 9-47. HICCUP Short Circuit Protection



$I_{OUT} = 1 \text{ A}$  TPS6282x

图 9-48. HICCUP Short Circuit Protection (Zoom In)

## 10 Power Supply Recommendations

The device is designed to operate from an input voltage supply range from 2.4 V to 5.5 V. Ensure that the input power supply has a sufficient current rating for the application.

## 11 Layout

### 11.1 Layout Guidelines

The printed-circuit-board (PCB) layout is an important step to maintain the high performance of the device. See [# 11.2](#) for the recommended PCB layout.

- The input/output capacitors and the inductor should be placed as close as possible to the IC. This keeps the power traces short. Routing these power traces direct and wide results in low trace resistance and low parasitic inductance.
- The low side of the input and output capacitors must be connected properly to the GND pin to avoid a ground potential shift.
- The sense traces connected to FB is a signal trace. Special care should be taken to avoid noise being induced. Keep these traces away from SW nodes. The connection of the output voltage trace for the FB resistors should be made at the output capacitor.
- Refer to [# 11.2](#) for an example of component placement, routing and thermal design.

### 11.2 Layout Example

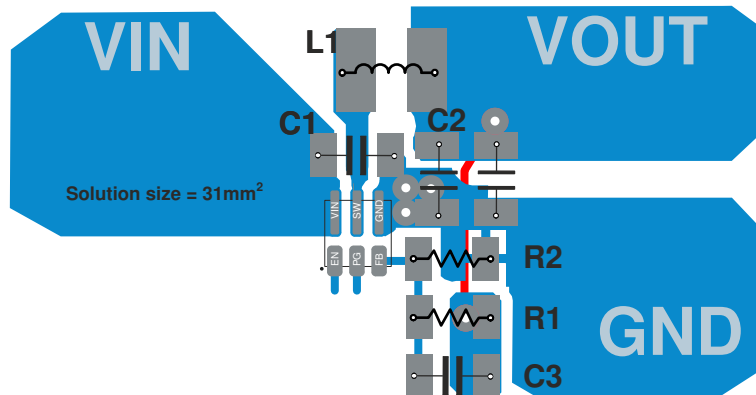


图 11-1. PCB Layout Recommendation

#### 11.2.1 Thermal Considerations

Implementation of integrated circuits in low-profile and fine-pitch surface-mount packages typically requires special attention to power dissipation. Many system-dependent issues such as thermal coupling, airflow, added heat sinks and convection surfaces, and the presence of other heat-generating components affect the power dissipation limits of a given component.

Two basic approaches for enhancing thermal performance are:

- Improving the power dissipation capability of the PCB design
- Introducing airflow in the system

The Thermal Data section in [# 7.4](#) provides the thermal metric of the device on the EVM after considering the PCB design of real applications. The big copper planes connecting to the pads of the IC on the PCB improve the thermal performance of the device. For more details on how to use the thermal parameters, see the *Thermal Characteristics Application Notes*, [SZZA017](#) and [SPRA953](#).

## 12 Device and Documentation Support

### 12.1 Device Support

#### 12.1.1 第三方产品免责声明

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#### 12.1.2 Development Support

##### 12.1.2.1 Custom Design With WEBENCH® Tools

[Click here](#) to create a custom design using the TPS6282x device with the WEBENCH® Power Designer.

1. Start by entering the input voltage ( $V_{IN}$ ), output voltage ( $V_{OUT}$ ), and output current ( $I_{OUT}$ ) requirements.
2. Optimize the design for key parameters such as efficiency, footprint, and cost using the optimizer dial.
3. Compare the generated design with other possible solutions from Texas Instruments.

The WEBENCH Power Designer provides a customized schematic along with a list of materials with real-time pricing and component availability.

In most cases, these actions are available:

- Run electrical simulations to see important waveforms and circuit performance
- Run thermal simulations to understand board thermal performance
- Export customized schematic and layout into popular CAD formats
- Print PDF reports for the design, and share the design with colleagues

Get more information about WEBENCH tools at [www.ti.com/WEBENCH](http://www.ti.com/WEBENCH).

### 12.2 Documentation Support

#### 12.2.1 Related Documentation

For related documentation, see the following:

- *Thermal Characteristics Application Note*, [SZZA017](#)
- *Thermal Characteristics Application Note*, [SPRA953](#)

### 12.3 支持资源

TI E2E™ 支持论坛是工程师的重要参考资料，可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《使用条款》。

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### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.6 术语表

#### TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS62824ADMQR    | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | JM                      | <a href="#">Samples</a> |
| TPS62824DMQR     | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | JL                      | <a href="#">Samples</a> |
| TPS6282518DMQR   | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CJ                      | <a href="#">Samples</a> |
| TPS6282518DMQT   | ACTIVE        | VSON-HR      | DMQ             | 6    | 250         | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CJ                      | <a href="#">Samples</a> |
| TPS6282533DMQR   | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | L1                      | <a href="#">Samples</a> |
| TPS62825ADMQR    | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | JN                      | <a href="#">Samples</a> |
| TPS62825DMQR     | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | CI                      | <a href="#">Samples</a> |
| TPS62825DMQT     | ACTIVE        | VSON-HR      | DMQ             | 6    | 250         | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CI                      | <a href="#">Samples</a> |
| TPS6282618DMQR   | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CK                      | <a href="#">Samples</a> |
| TPS6282618DMQT   | ACTIVE        | VSON-HR      | DMQ             | 6    | 250         | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CK                      | <a href="#">Samples</a> |
| TPS62826ADMQR    | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | JO                      | <a href="#">Samples</a> |
| TPS62826DMQR     | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CL                      | <a href="#">Samples</a> |
| TPS62826DMQT     | ACTIVE        | VSON-HR      | DMQ             | 6    | 250         | RoHS & Green    | Call TI   SN   NIPDAU                | Level-1-260C-UNLIM   | -40 to 125   | CL                      | <a href="#">Samples</a> |
| TPS62827ADMQR    | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | JP                      | <a href="#">Samples</a> |
| TPS62827DMQR     | ACTIVE        | VSON-HR      | DMQ             | 6    | 3000        | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | EH                      | <a href="#">Samples</a> |
| TPS62827DMQT     | ACTIVE        | VSON-HR      | DMQ             | 6    | 250         | RoHS & Green    | Call TI   NIPDAU                     | Level-1-260C-UNLIM   | -40 to 125   | EH                      | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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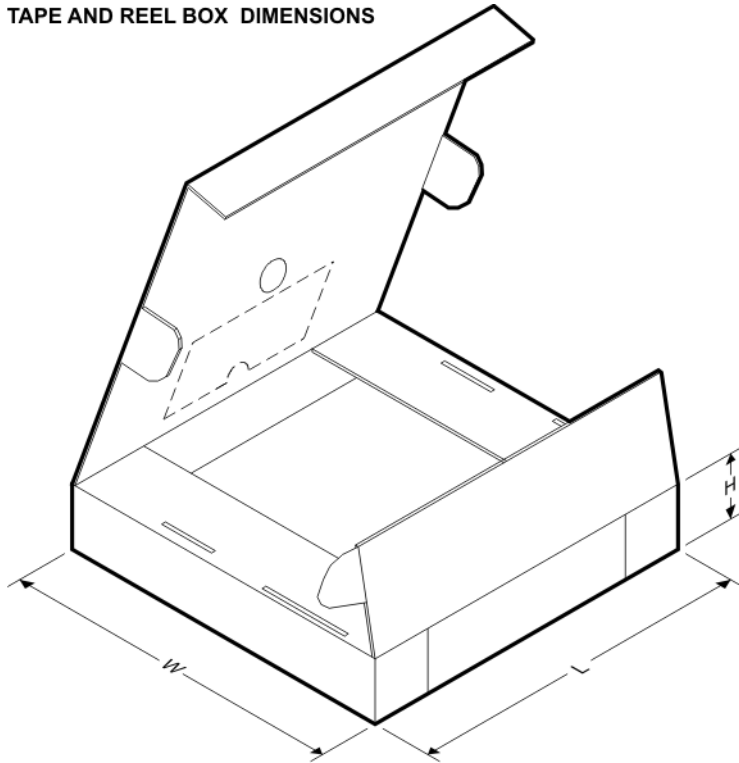
**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS62824ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62824DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS6282518DMQR | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS6282518DMQR | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS6282518DMQT | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS6282518DMQT | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS6282533DMQR | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS62825ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62825DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62825DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS62825DMQT   | VSON-        | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
|                | HR           |                 |      |      |                    |                    |         |         |         |         |        |               |
| TPS62825DMQT   | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS6282618DMQR | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS6282618DMQR | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS6282618DMQT | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS6282618DMQT | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62826ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62826DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62826DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS62826DMQT   | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62826DMQT   | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS62827ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62827DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.75    | 1.75    | 1.0     | 4.0     | 8.0    | Q2            |
| TPS62827DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |
| TPS62827DMQT   | VSON-HR      | DMQ             | 6    | 250  | 180.0              | 8.4                | 1.7     | 1.7     | 1.14    | 4.0     | 8.0    | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS62824ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62824DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS6282518DMQR | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS6282518DMQR | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS6282518DMQT | VSON-HR      | DMQ             | 6    | 250  | 182.0       | 182.0      | 20.0        |
| TPS6282518DMQT | VSON-HR      | DMQ             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS6282533DMQR | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS62825ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62825DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62825DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS62825DMQT   | VSON-HR      | DMQ             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS62825DMQT   | VSON-HR      | DMQ             | 6    | 250  | 182.0       | 182.0      | 20.0        |
| TPS6282618DMQR | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS6282618DMQR | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS6282618DMQT | VSON-HR      | DMQ             | 6    | 250  | 182.0       | 182.0      | 20.0        |
| TPS6282618DMQT | VSON-HR      | DMQ             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS62826ADMQR  | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62826DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62826DMQR   | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS62826DMQT   | VSON-HR      | DMQ             | 6    | 250  | 210.0       | 185.0      | 35.0        |

---

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS62826DMQT  | VSON-HR      | DMQ             | 6    | 250  | 182.0       | 182.0      | 20.0        |
| TPS62827ADMQR | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62827DMQR  | VSON-HR      | DMQ             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62827DMQR  | VSON-HR      | DMQ             | 6    | 3000 | 182.0       | 182.0      | 20.0        |
| TPS62827DMQT  | VSON-HR      | DMQ             | 6    | 250  | 182.0       | 182.0      | 20.0        |

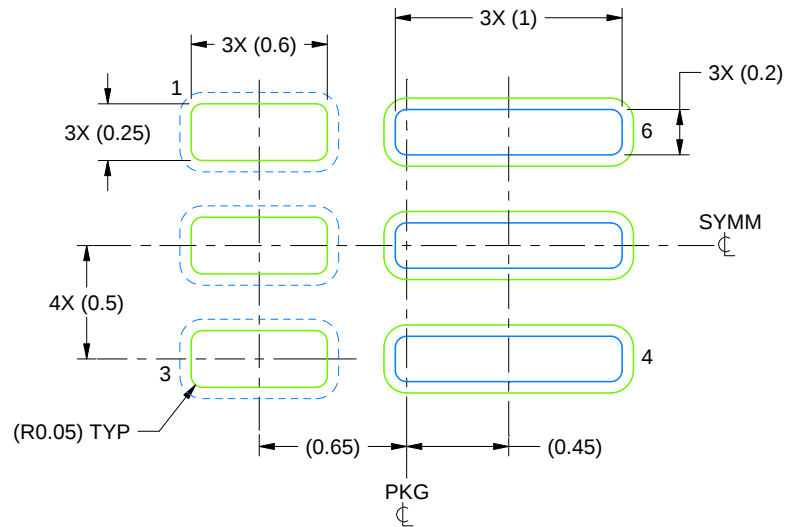


# EXAMPLE BOARD LAYOUT

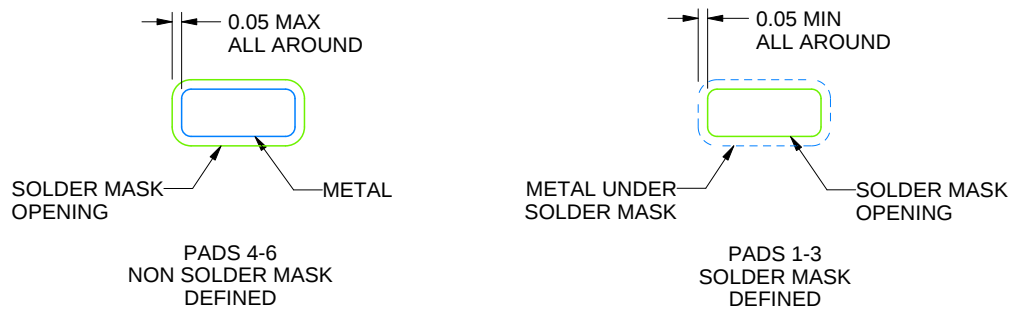
DMQ0006A

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:30X



SOLDER MASK DETAILS

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NOTES: (continued)

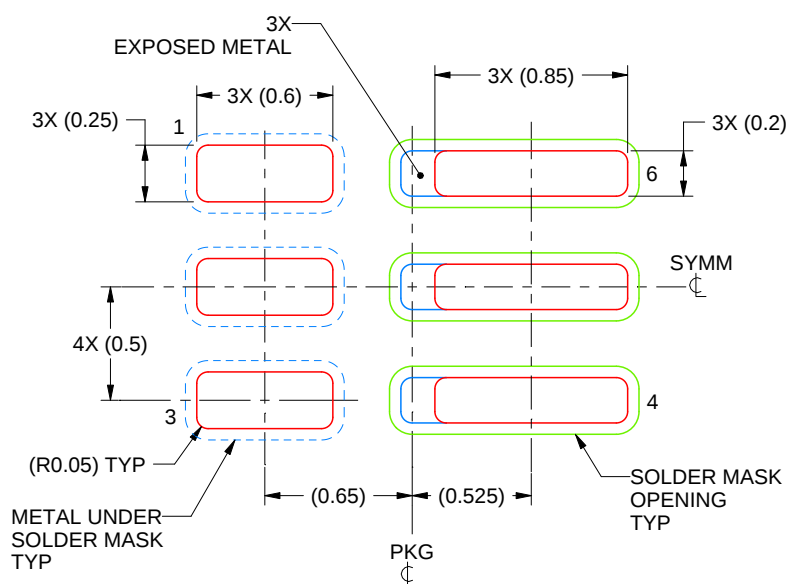
3. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

# EXAMPLE STENCIL DESIGN

DMQ0006A

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

PADS 4, 5 & 6:  
81% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:30X

4222645/C 10/2020

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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